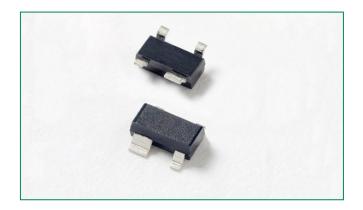
TVS Diode Arrays (SPA® Diodes)

SR05 Series 5V 25A Diode Array







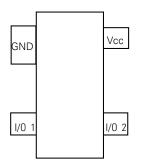


Description

The SR05 consists of four, low capacitance steering diodes and a low voltage TVS diode that provide protection against ESD and lightning surge events. Each channel or I/O pin can safely absorb up to 25A (tp=8/20µs) and repetitive ESD strikes above the maximum level (Level 4) specified in the IEC 61000-4-2 international standard without performance degradation.

The low loading capacitance makes it ideal for protecting high-speed telecommunication data lines.

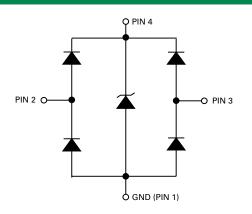
Pinout



Features

- ESD, IEC61000-4-2, ±30kV contact discharge, ±30kV air discharge
- EFT, IEC61000-4-4, 80A $(t_n = 5/50 ns)$
- · Lightning protection, IEC61000-4-5, 25A $(t_n = 8/20 \mu s)$
- Low capacitance of 6.0pF (TYP) per I/O
- · Low clamp voltage
- Small SOT143 (JEDEC TO-253) packaging
- Moisture Sensitivity Level (MSL-1)

Functional Block Diagram



Applications

- T1/E1 IC/Secondary Protection
- Ethernet 10BaseT
- WAN/LAN Equipment
- ISDN S/T Interface
- Video Lines
- Microcontroller Input Protection

Additional Information

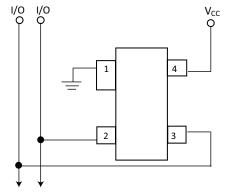






Samples

Application Example



The SR05 integrates a TVS Diode between the Vcc and Gnd pins. This allows the array to protect the power supply against ESD and lighting surges when these pins are both connected in the application.

Life Support Note:

Not Intended for Use in Life Support or Life Saving Applications

The products shown herein are not designed for use in life sustaining or life saving applications unless otherwise expressly indicated.



Absolute Maximum Ratings				
Symbol	Parameter Value Un			
I _{PP}	Peak Current (t _p =8/20µs)	25.0	А	
P _{Pk}	Peak Pulse Power (t _p =8/20µs)	450	W	
T _{OP}	Operating Temperature	-40 to 125	°C	
T _{STOR}	Storage Temperature	-55 to 150	°C	

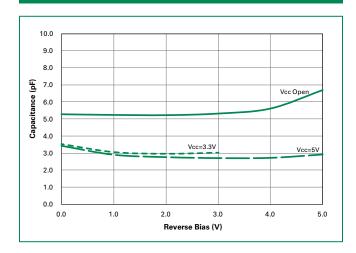
Thermal Information				
Parameter	Rating	Units		
Storage Temperature Range	-55 to 150	°C		
Maximum Junction Temperature	150	°C		
Maximum Lead Temperature (Soldering 20-40s)	260	°C		

CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

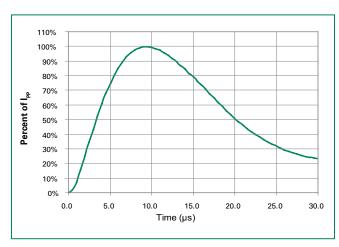
Electrical Characteristics (T _{OP} =25°C)						
Parameter	Symbol	Test Conditions	Min	Тур	Max	Units
Reverse Stand-Off Voltage	V _{RWM}		-	-	5.0	V
Reverse Leakage Current	I _R	V_R = 5V, I/O to GND	-	-	5.0	μΑ
Reverse Breakdown Voltage	V _{BR}	$I_t = 1 \text{mA}$	6.0	-	-	V
Clamping Voltage, Line-Ground ¹	V _C	I _{pp} = 1A, t _p =8/20 μs	-	-	9.8	V
Clamping Voltage, Line-Ground ¹	V _C	I _{PP} = 10A, t _p =8/20 μs	-	-	12.0	V
Clamping Voltage, Line-Ground ¹	V _C	I _{PP} = 25A, t _p =8/20 μs	-	-	18.0	V
Dynamic Resistance, Line-Ground ¹	R _{DYN}	(V _{C2} -V _{C1})/(I _{PP2} -I _{PP1})	-	0.3	-	Ω
ESD Withstand Voltage ¹	\/	IEC61000-4-2 (Contact Discharge)	±30	-	-	kV
	V _{ESD}	IEC61000-4-2 (Air Discharge)	±30			kV
Diada Canasitanas1	C _{I/O-I/O}	Reverse Bias=0V	-	3.0	-	pF
Diode Capacitance ¹	C _{I/O-GND}	Reverse Bias=0V	-	6.0	10.0	pF

Note: 1. Parameter is guaranteed by design and/or device characterization.

Capacitance vs. Reverse Bias

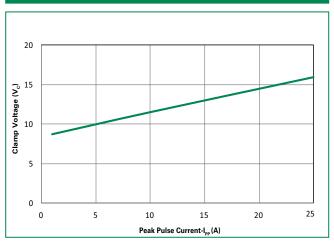


8/20µs Pulse Waveform



TVS Diode Arrays (SPA® Diodes) Lightning Surge Protection- SR05 Series

Clamping Voltage vs. Ipp



Product Characteristics

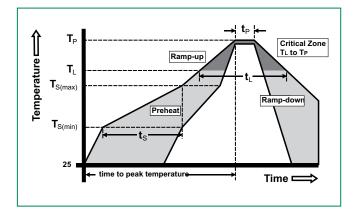
Lead Plating	Matte Tin	
Lead Material	Copper Alloy	
Lead Coplanarity	0.0004 inches (0.102mm)	
Substitute Material	Silicon	
Body Material	Molded Epoxy	
Flammability	UL 94 V-0	

- Notes:
 1. All dimensions are in millimeters

- 1. Au unterisoins are imminiments.
 2. Dimensions include solder plating.
 3. Dimensions are exclusive of mold flash & metal burr.
 4. Blo is facing up for mold and facing down for trim/form, i.e. reverse trim/form.
 5. Package surface matte finish VDI 11-13.

Soldering Parameters

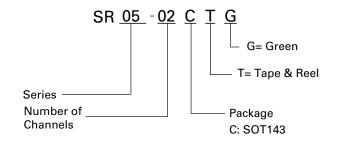
Reflow Condition		Pb – Free assembly		
	-Temperature Min (T _{s(min)})	150°C		
Pre Heat	-Temperature Max (T _{s(max)})	200°C		
	-Time (min to max) (t _s)	60 – 180 secs		
Average ramp up rate (Liquidus) Temp (T _L) to peak		3°C/second max		
T _{S(max)} to T	_L - Ramp-up Rate	3°C/second max		
Reflow	-Temperature (T _L) (Liquidus)	217°C		
nellow	-Temperature (t _L)	60 – 150 seconds		
PeakTemp	perature (T _P)	260+0/-5 °C		
Time with	in 5°C of actual peak ure (t _p)	20 – 40 seconds		
Ramp-down Rate		6°C/second max		
Time 25°C to peakTemperature (T _P)		8 minutes Max.		
Do not exceed		260°C		



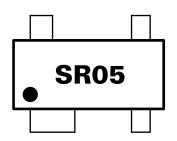
Ordering Information

Part Number	Package	Marking	Min. Order Qty.
SR05-02CTG	SOT143	SR05	3000

Part Numbering System

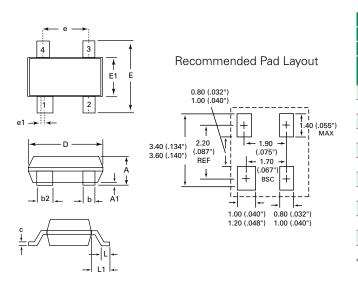


Part Marking System



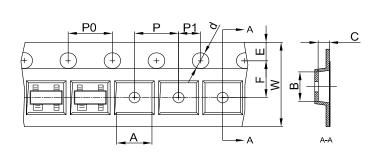


Package Dimensions—SOT143

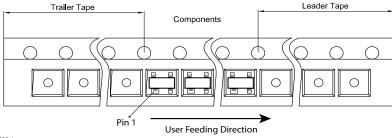


Package	SOT143			
Pins		4	4	
JEDEC		TO-	253	
	Millin	neters	Inc	hes
	Min	Max	Min	Max
Α	0.8	1.22	0.03	0.048
A1	0.05	0.15	0.002	0.006
b	0.30	0.50	0.012	0.020
b2	0.76	0.89	0.030	0.035
С	0.08	0.20	0.003	0.008
D	2.80	3.04	0.110	0.120
E	2.10	2.64	0.082	0.104
E1	1.20	1.40	0.047	0.055
е	1.92 BSC		0.076	BSC
e1	0.20 BSC		0.008 BSC	
L	0.4	0.6	0.016	0.024
L1	0.550 REF		0.022	REF

Embossed Carrier Tape & Reel Specification - SOT143



Symbol	Millimeters	
Α	3.19±0.10	
В	2.8±0.10	
С	1.31±0.10	
d	Ø 1.50±0.10	
E	1.75±0.10	
F	3.50±0.10	
P0	4.00±0.10	
Р	4.00±0.10	
P1	2.00±0.10	
w	8.00±0.10	



Notes :
1. All dimensions are in millimeters

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